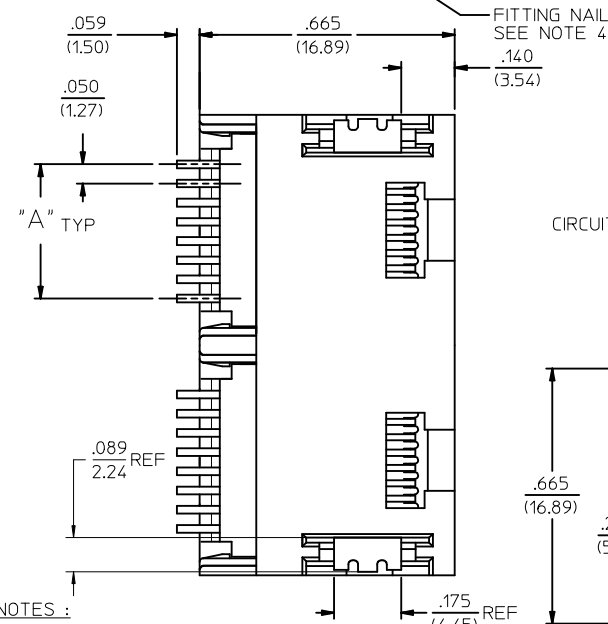
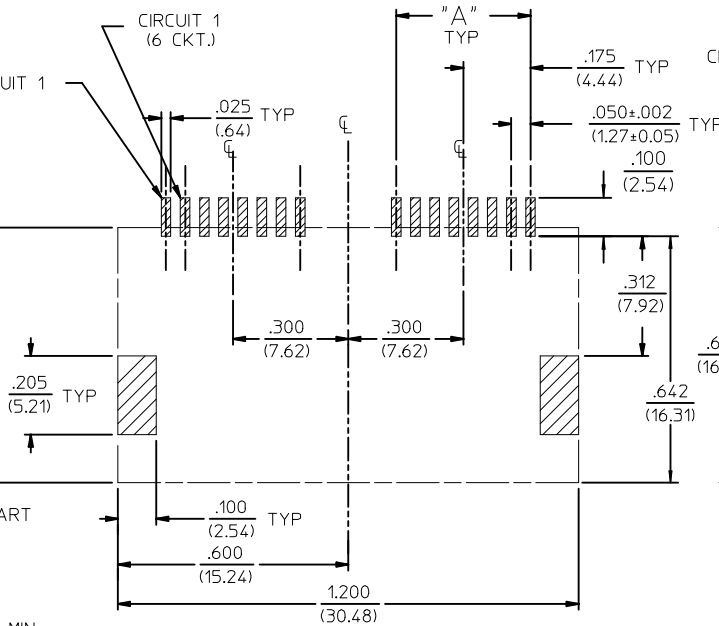


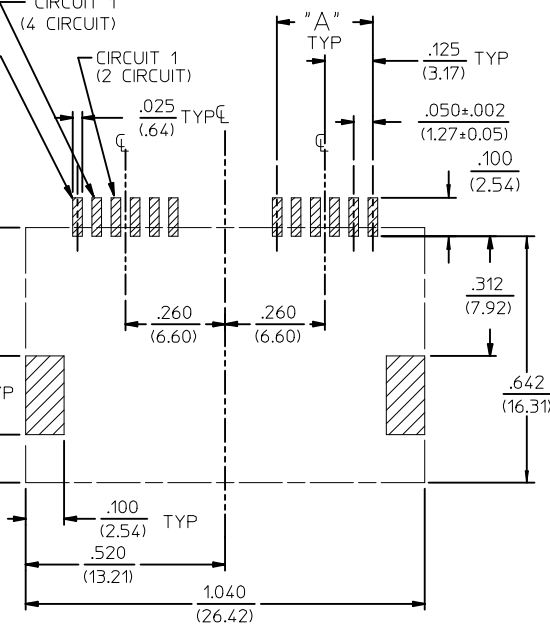


NOTES :

- 1) MATERIALS :
HOUSING : NYLON, GLASS-FILLED, UL94V-0, COLOR - SEE CHART
TERMINALS : PHOSPHOR BRONZE, .012/(0.30)
FITTING NAILS : BRASS ALLOY, .010/(0.25)
- 2) FINISH :
TERMINAL PLATING OPTIONS : (SEE TABLE)
(A) SELECT GOLD IN CONTACT AREA: .000050/(0.00127) MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: .000100/(0.00254) MIN.,
WITH OVERALL NICKEL UNDERPLATE: .000050/(0.00127) MIN.
(B) SELECT GOLD IN CONTACT AREA: .000030/(0.00076) MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: .000100/(0.00254) MIN.,
WITH OVERALL NICKEL UNDERPLATE: .000050/(0.00127) MIN.
(C) SELECT GOLD IN CONTACT AREA: .000015/(0.00038) MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: .000100/(0.00254) MIN.,
WITH OVERALL NICKEL UNDERPLATE: .000050/(0.00127) MIN.
FITTING NAILS :
*100 MICROINCHES MATTE TIN OVER 50 MICROINCHES NICKEL UNDERPLATE
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "ELV AND
RoHS COMPLIANT". CARTONS WITHOUT THIS LABEL MAY
CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAIL AREA.
- 3) PRODUCT SPECIFICATION : PS-43743-001
- 4) COPLANARITY SPECIFICATIONS:
WITH THE MODULAR JACK SITTING ON A LEVEL SURFACE, THE MAXIMUM GAP BETWEEN
THE LEVEL SURFACE AND ALL TERMINAL TAILS AND BOTH FITTING NAILS IS .006/(0.15).
- 5) FOR ASSEMBLIES HAVING VOIDED CIRCUITS, THE TAIL PORTION IS CUT
AND REMOVED. THE MATING PORTION OF THE TERMINAL REMAINS INTACT.
VOIDED CIRCUITS MUST BE THE SAME FOR BOTH PORTS.
- 6) CONVECTION SOLDERING TECHNOLOGY SHOULD BE USED WHEN GANGING MODULAR
JACKS WITH INBOARD NAILS SIDE-BY-SIDE.
- 7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



PC BOARD LAYOUT FOR
8 POSITION HOUSING
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR
6 POSITION HOUSING
(COMPONENT SIDE OF BOARD)

REVISED NOTES EC NO: UCP2009-1244 DRAWN: JLOSTNER 08/12/10 CHKD: JELL 2/08/08/12/10 APPR: F3MITH 2/08/08/12/10	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 1:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
			mm	INCH	DRAWN BY MUELLER	DATE 98/06/11	TITLE 4, 6, & 8 CIRCUIT DUAL PORT SMT MODULAR JACK W/ FLUSH MOUNT NAILS			
			4 PLACES ± --- ± ---	3 PLACES ± --- ± .010	CHECKED BY ROBERTS	DATE 98/06/16				
			2 PLACES ± 0.25 ± .015	1 PLACE ± 0.38 ± ---	APPROVED BY EDGLEY	DATE 98/06/17				
			ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.			SHEET NO.
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHT 2		SD-44193-001			1 OF 2
G2	REV		C THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Molex:](#)

[44193-0015](#)